

Vishay Siliconix

Dual N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)			
20	0.018 at V _{GS} = 4.5 V	8	10 nC			
20	0.022 at $V_{GS} = 2.5 \text{ V}$	8	10110			

FEATURES

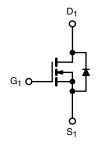
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

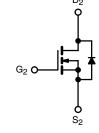


ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC Converter
 - Game Machine
 - PC





N-Channel MOSFET

N-Channel MOSFET

	SO-8		
S ₁ 1 G ₁ 2 S ₂ 3 G ₂ 4		8 7 6 5	D ₁ D ₁ D ₂ D ₂
	Top View	_	

Ordering Information: Si9926CDY-T1-E3 (Lead (Pb)-free)

Si9926CDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATIN	IGS $T_A = 25 ^{\circ}C$,	unless othe	erwise noted	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V_{DS}	20	V
Gate-Source Voltage		V_{GS}	± 12	V
	T _C = 25 °C		8 ^a	
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	I _D	8 ^a	
Sommadus Brain Sancin (1) = 100 G)	T _A = 25 °C	טי	8 ^{a, b, c}	
	T _A = 70 °C		6.7 ^{b, c}	A
Pulsed Drain Current	,		30	^
Continuous Source-Drain Diode Current	T _C = 25 °C	la	2.6	
Continuous Source-Diam Diode Current	T _A = 25 °C	- I _S	1.7 ^{b, c}	
Single Pulse Avalanche Current L = 0.1 mH		I _{AS}	5	
Single Pulse Avalanche Energy		E _{AS}	1.25	mJ
	T _C = 25 °C		3.1	
Maximum Power Dissipation	T _C = 70 °C	P _D	2	w
Maximum Fower Dissipation	T _A = 25 °C	ט' ט	2 ^{b, c}	VV
	T _A = 70 °C	1	1.3 ^{b, c}	
Operating Junction and Storage Temperatur	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, c, d}	t ≤ 10 s	R _{thJA}	50	62.5	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{th,IF}$	32	40	J/ VV	

Notes:

- a. Package limited, T_C = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under Steady State conditions is 110 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		25		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 4.0		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	0.6		1.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zana Oata Wallana Busin Oamant		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	30			Α
		$V_{GS} = 4.5 \text{ V}, I_D = 8.3 \text{ A}$		0.015	0.018	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 4.5 A		0.017	0.022	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 8.3 A		45		S
Dynamic ^b					<u> </u>	
Input Capacitance	C _{iss}			1200		
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		220		pF
Reverse Transfer Capacitance	C _{rss}			100		
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 8.3 \text{ A}$		22	33	nC
				10	15	
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8.3 \text{ A}$		2.5		
Gate-Drain Charge	Q_{gd}			1.7		
Gate Resistance	R_{g}	f = 1 MHz	f = 1 MHz			Ω
Turn-on Delay Time	t _{d(on)}			15	25	
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.5 Ω		10	15	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7~A,~V_{GEN}=4.5~V,~R_g=1~\Omega$		35	55	
Fall Time	t _f			12	20	
Turn-on Delay Time	t _{d(on)}			10	15	ns
Rise Time	t _r	V_{DD} = 10 V, R_L = 1.5 Ω		12	20	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong 6.7$ A, V_{GEN} = 10 V, R_g = 1 Ω		25	40	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristi	cs					
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			2.6	۸
Pulse Diode Forward Current	I _{SM}				30	A
Body Diode Voltage	V_{SD}	I _S = 6.7 A, V _{GS} = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			20	40	ns
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F = 6.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		10	20	nC
Reverse Recovery Fall Time	ta	i _F = 0.7 A, αί/αι = 100 A/μs, 1 _J = 25 °C		10		
Reverse Recovery Rise Time	t _b			10		ns

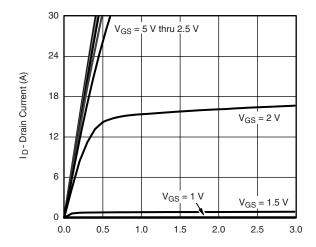
- a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



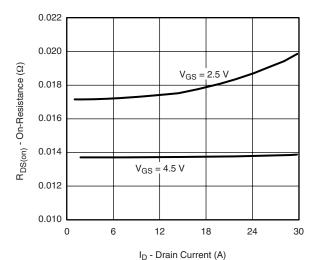
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

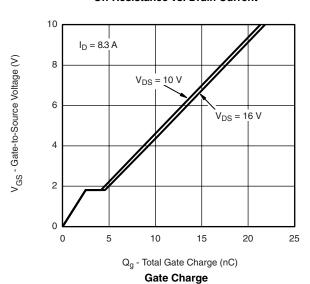


V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics

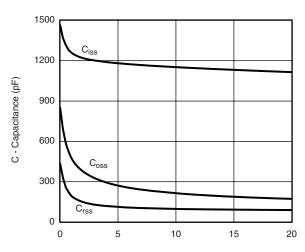


On-Resistance vs. Drain Current



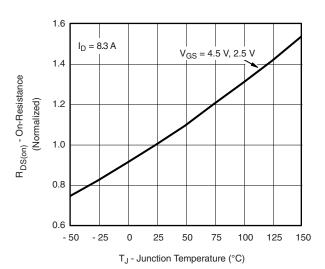
 $T_{C} = -55 \, ^{\circ}C$ To a sum of the contract of the contra

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



V_{DS} - Drain-to-Source Voltage (V)

Capacitance

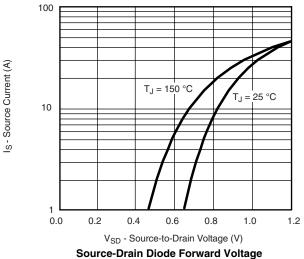


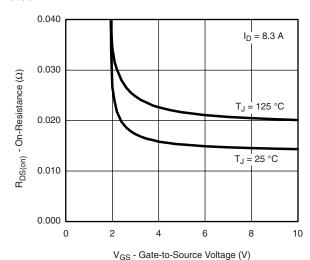
On-Resistance vs. Junction Temperature

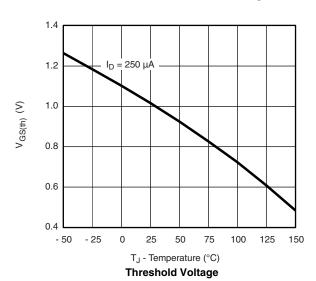
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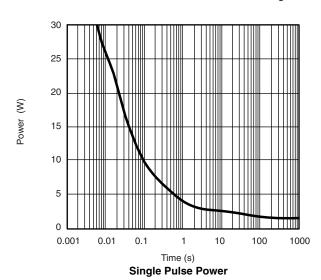
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

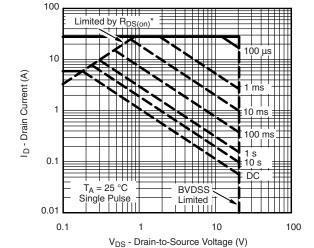






On-Resistance vs. Gate-to-Source Voltage





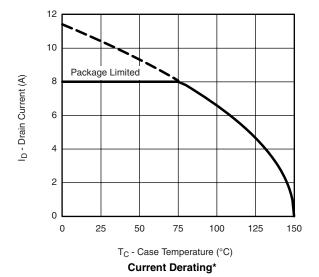
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

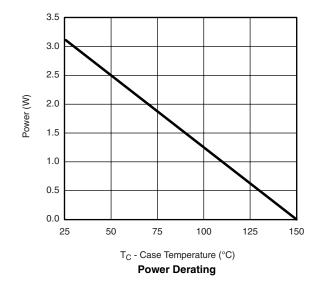
Safe Operating Area, Junction-to-Ambient



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





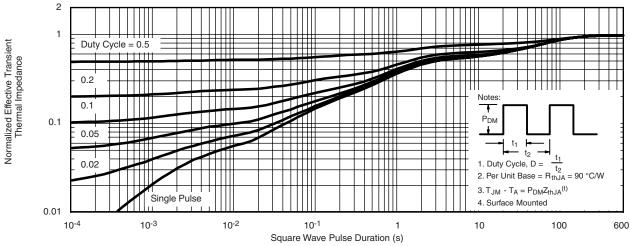
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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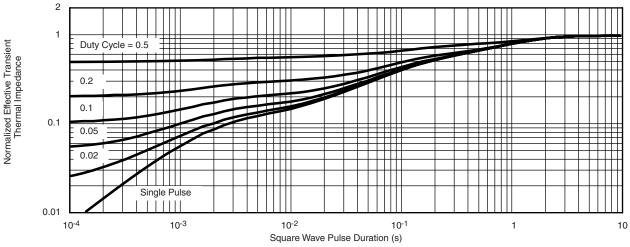
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68606.



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHES		HES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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